

To: Technology Unit: 2814
Facsimile Number: 703-872-9306

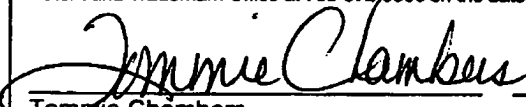
Total Pages Sent 3

From: W. Daniel Swayze, Jr.
Texas Instruments Incorporated
Facsimile: 972-917-4418
Phone: 972-917-5633

RECEIVED
CENTRAL FAX CENTER

NOV 12 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

CERTIFICATION OF FACSIMILE TRANSMISSION	
I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at 703-872-9306 on the date shown below:	
 Tommie Chambers	11-12-04 Date

FACSIMILE COVER SHEET

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET	<input type="checkbox"/> AMENDMENT (# Pages)
<input type="checkbox"/> NEW APPLICATION	<input checked="" type="checkbox"/> EOT (1 Month)
<input type="checkbox"/> DECLARATION (# Pages)	<input checked="" type="checkbox"/> NOTICE OF APPEAL
<input type="checkbox"/> ASSIGNMENT (# Pages)	<input type="checkbox"/> APPEAL (# Pages)
<input type="checkbox"/> FORMAL DRAWINGS	<input type="checkbox"/> ISSUE FEE (# Pages)
<input type="checkbox"/> INFORMAL DRAWINGS	<input type="checkbox"/> CHANGE IN CORRESPONDENCE
<input type="checkbox"/> CONTINUATION APPN (# Pages)	<input type="checkbox"/> ADDRESS
<input type="checkbox"/> DIVISIONAL APPN	
NAME OF INVENTOR(S): Yew	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/612,129 Filing Date: 7/2/2003	
TITLE OF INVENTION: DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC SUBSTRATE	
TI FILE NO.: TI-26239.1	DEPOSIT ACCT. NO.: 20-0668
FAXED: 11-12-04 DUE: 11/08/2004 ATTY/SECY: WDS/tic	

This facsimile is intended only for the use of the address named and contains legally privileged and/or confidential information. If you are not the intended recipient of this telecopy, you are hereby notified that any dissemination, distribution, copying or use of this communication is strictly prohibited. Applicable privileges are not waived by virtue of the document having been transmitted by Facsimile. Any misdirected facsimiles should be returned to the sender by mail at the address indicated on this cover sheet.

Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75265

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Yew, et al.

Docket No: TI-26239.1

Serial No: 10/612,129

Examiner: Cao, Phat X.

Filed: 7/2/2003

Art Unit: 2814

For: DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC SUBSTRATE

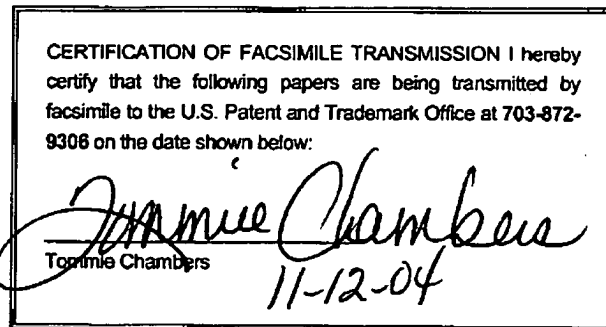
RECEIVED
CENTRAL FAX CENTER

NOV 12 2004

**NOTICE OF APPEAL FROM THE PRIMARY EXAMINER
TO THE BOARD OF APPEALS**

Assistant Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Dear Sir:



Applicant hereby appeals to the Board of Appeals from the decision mailed August 6, 2004, of the Primary Examiner finally rejecting Claims 1-2, and 4-15.

The item(s) checked below are appropriate:

1. ☒ An extension of time to respond to the final rejection
_____ was granted on _____.
☒ is requested for 1 month.
2. _____ A timely response to the final rejection has been filed, as provided in 841 O.G. 1411.
3. ☒ Fee \$340.00:
_____ Not required (Fee paid in prior appeal)
☒ The Commissioner of Patents is hereby authorized to charge any fees which may be required or credit any overpayment to the deposit account of Texas Instruments Incorporated, Account No. 20-0668.
This form is submitted in duplicate.

Texas Instruments Incorporated
P.O. Box 655474, MS 3999
Dallas, TX 75265
(972) 917-5633

W. Daniel Swayze, Jr.
W. Daniel Swayze, Jr.
Attorney for Appellant
Reg. No. 34,478